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FDB024N08BL7 N-Channel PowerTrench[®] MOSFET 80 V, 229 A, 2.4 mΩ

Features

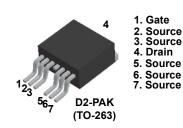
- R_{DS(on)} = 1.7 mΩ (Typ.) @ V_{GS} = 10 V, I_D = 100 A
- Low FOM R_{DS(on)} *Q_G
- Low Reverse Recovery Charge, Q_{rr} = 112 nC
- Soft Reverse Recovery Body Diode
- Enables Highly Efficiency in Synchronous Rectification
- · Fast Switching Speed
- RoHS Compliant
- Qualified according to JEDEC Standards JESD22-A113F and IPC/JEDEC J-STD-020D.1

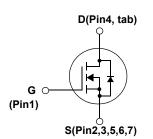
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor drives and Uninterruptible Power Supplies





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		FDB024N08BL7	Unit		
V _{DSS}	Drain to Source Voltage	80	V		
V _{GSS}	Gate to Source Voltage	±20	V		
		- Continuous (T _C = 25 ^o C, Silicon Limited)	229*	A	
I _D	Drain Current	- Continuous (T _C = 100 ^o C, Silicon Limited)	162*		
		- Continuous (T _C = 25 ^o C, Package Limited)	120		
I _{DM}	Drain Current	- Pulsed (Note 1)	916	А	
E _{AS}	Single Pulsed Avalanche E	917	mJ		
dv/dt	Peak Diode Recovery dv/d	6.0	V/ns		
P _D	Dewen Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$	246	W	
	Power Dissipation	- Derate Above 25°C	1.64	W/ºC	
T _J , T _{STG}	Operating and Storage Ter	-55 to +175	°C		
TL	Maximum Lead Temperatu 1/8" from Case for 5 Secor	300	°C		

*Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120 A.

Thermal Characteristics

Symbol	Parameter	FDB024N08BL7	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.61	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W

FDB024N08BL7 N-Channel PowerTrench[®] MOSFET

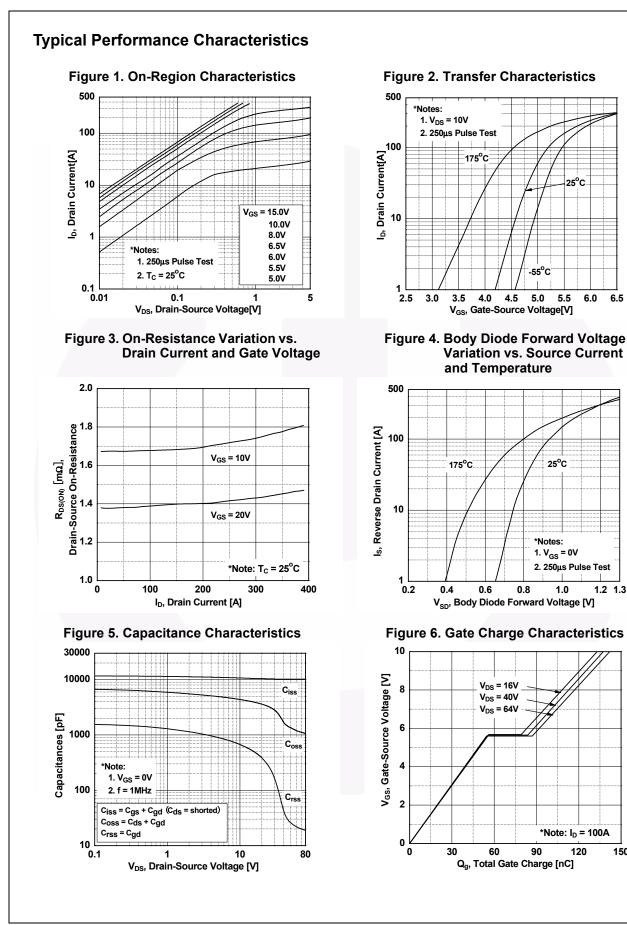
Part Nu	ımber	Top Mark	Package	ackage Packing Method		Тар	e Width	Qua	ntity
		D2PAK-7L	K-7L Tape and Reel 330 mm		24 mm		800 units		
Electrica	al Chara	acteristics $T_c = 2$	5ºC unless o	therwise noted					
Symbol		Parameter		Test Conditi	ions	Min.	Тур.	Max.	Unit
Off Chara	cteristics	5							
BV _{DSS}	Drain to Source Breakdown Voltage		tage	I _D = 250 μA, V _{GS} = 0 V			-	_	V
ΔBV _{DSS}		Breakdown Voltage Temperature				80			
ΔT_J	Coefficient		-	$I_D = 250 \ \mu$ A, Referenced to 25° C		-	0.05	-	V/°C
1	Zoro Co	to Voltago Droin Curror	.+	$V_{DS} = 64 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_{DS} = 64 V, V _{GS} = 0 V		-	1	
DSS	Zero Ga	Zero Gate Voltage Drain Current		$V_{DS} = 64 \text{ V}, \text{ T}_{C} = 150^{\circ}\text{C}$			-	500	μA
GSS	Gate to Body Leakage Current			$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$	V	-	-	±100	nA
On Chara	otoristics								
		reshold Voltage		V _{GS} = V _{DS} , I _D = 250 μ	Δ	2.5	-	4.5	V
V _{GS(th)}		ain to Source On Resis	tance	$V_{GS} = V_{DS}, I_D = 230 \mu$ $V_{GS} = 10 V, I_D = 100 A$		2.5	1.7	2.4	mΩ
R _{DS(on)} 9 _{FS}		Transconductance		$V_{\rm DS} = 10$ V, $I_{\rm D} = 100$ A		-	227	-	S
					·				
Dynamic (
C _{iss}	•	pacitance		V _{DS} = 40 V, V _{GS} = 0 V, f = 1 MHz		-	10170	13530	pF
C _{oss}		Capacitance				-	1670	2220	pF
C _{rss}		Transfer Capacitance				-	35	-	pF
C _{oss} (er)		elated Output Capacita	nce	$V_{DS} = 40 V, V_{GS} = 0 V$	/	-	3025	-	pF
Q _{g(tot)}		te Charge at 10V		$V_{-1} = 40 V_{-1} V_{-1} = 10$	V	-	137	178	nC
Q _{gs}		Source Gate Charge		$V_{DS} = 40 \text{ V}, V_{GS} = 10 \text{ V},$ $I_{D} = 100 \text{ A}$		-	56	-	nC
Q _{gs2}		arge Threshold to Plate	au			-	25	-	nC
Q _{gd}		Drain "Miller" Charge		6 4841	(Note 4)	-	28	-	nC
ESR	Equivale	nt Series Resistance (0	j-S)	f = 1MHz		-	2.4	-	Ω
Switching	Charact	eristics							
t _{d(on)}	Turn-On	Delay Time				-	47	104	ns
t _r	Turn-On	Rise Time		$V_{DD} = 40 \text{ V}, \text{ I}_{D} = 100 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$ (Note 4)			66	142	ns
t _{d(off)}	Turn-Off	Delay Time				-	87	184	ns
t _f	Turn-Off	Fall Time				-	41	92	ns
Drain-Sou		o Charactoristics							
	Irce Diode Characteristics Maximum Continuous Drain to Source Diode Forward Current					-	_	229*	A
s	Maximum Pulsed Drain to Source Diode Fo					-	-	916	A
SM Vod	Drain to Source Diode Forward Voltage			$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 100 \text{ A}$			-	1.3	V
V _{SD}					-	80	-	ns	
t _{rr} Q _{rr}		Recovery Charge		V_{GS} = 0 V, V_{DD} = 40 V, I_{SD} = 100 A, dI _F /dt = 100 A/µs		-	112	-	nC

2. L = 3 mH, I_{AS} = 24.72 A, R_G = 25.02, starting T_J = 25°C. 3. $I_{SD} \le 100$ A, di/dt ≤ 200 A/µs, $V_{DD} \le BV_{DSS}$, starting T_J = 25°C. 4. Essentially independent of operating temperature typical characteristics.

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6.0 6.5

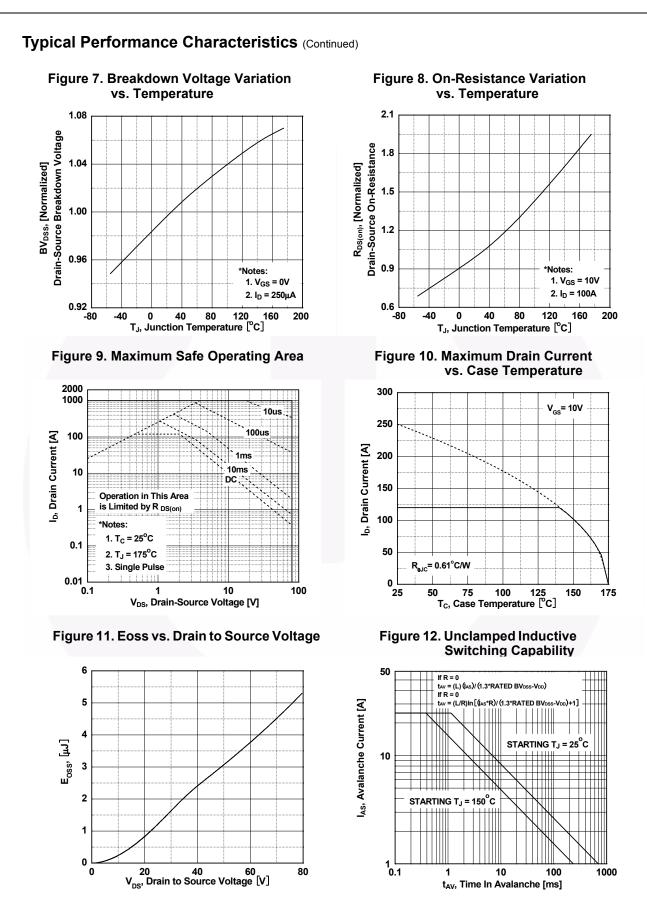
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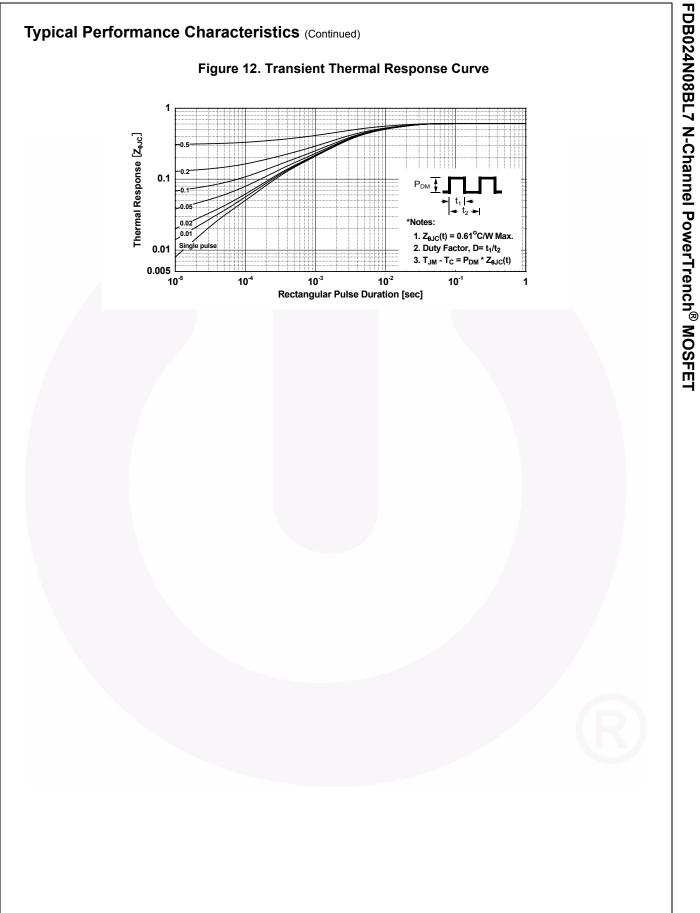
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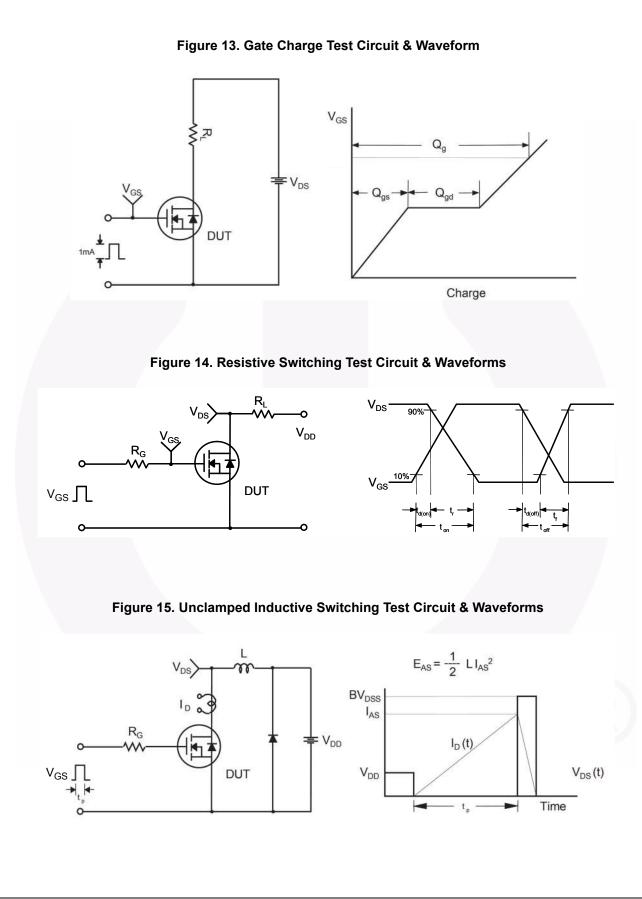
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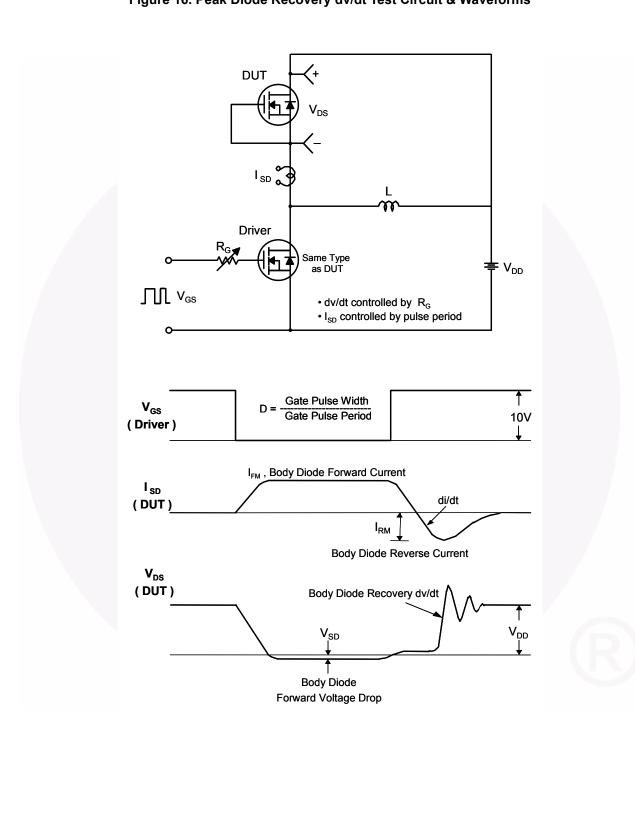


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

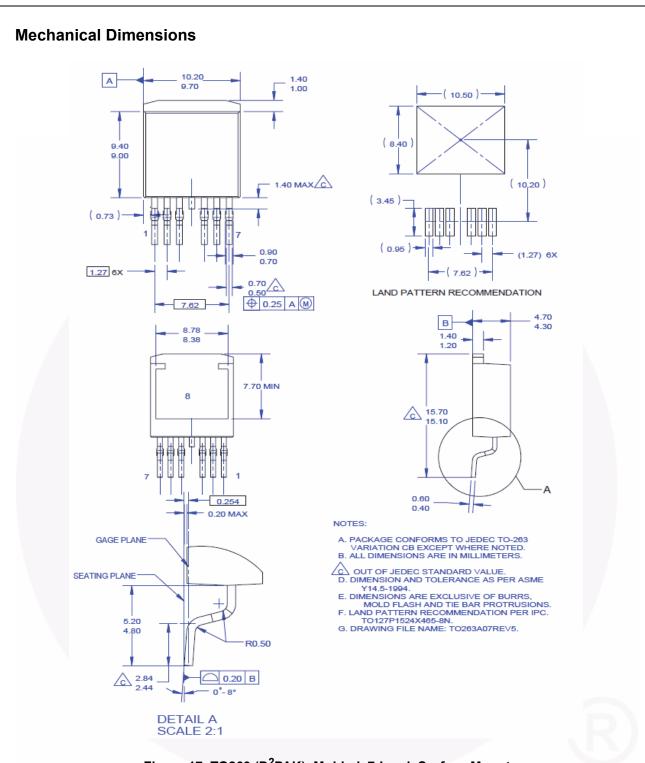
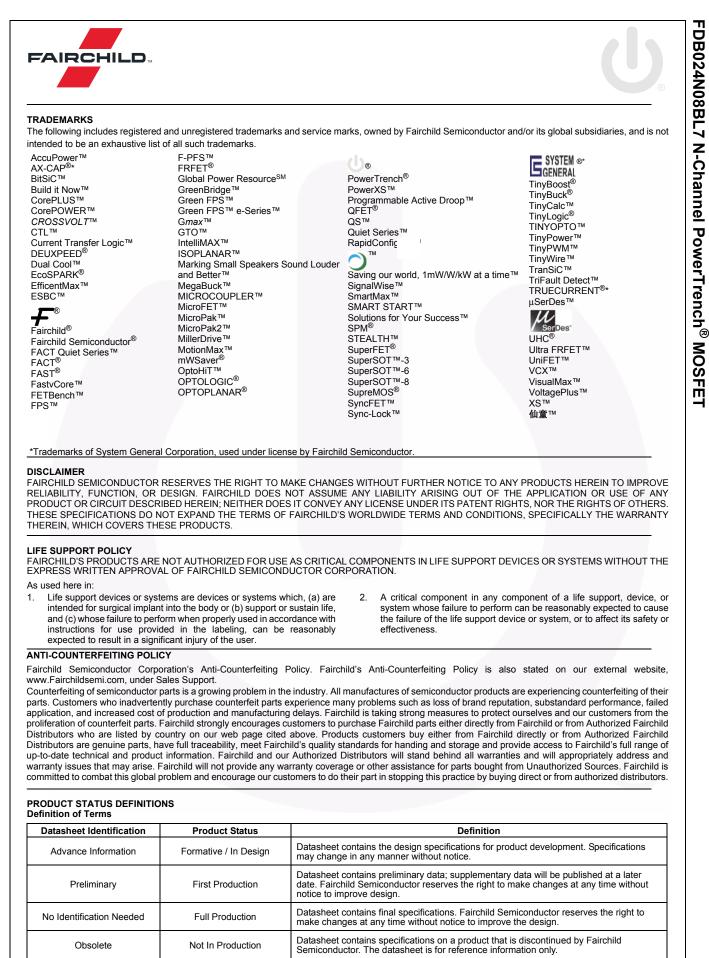


Figure 17. TO263 (D²PAK), Molded, 7-Lead, Surface Mount

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